# LOCTITE.

# LOCTITE<sup>®</sup> SI 5643

Two-component, fast curing, low viscosity thermally conductive potting compound for electronic assembly applications.

### **Features & Benefits**

- Exceptional and fast flowing behavior
- Pourable, fast, and self-levelling
- Capable of filling small gaps
- Provides excellent heat transfer
- Very soft to protect sensitive components
- Yellow in color, enabling easy automated optical inspection







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### **Typical Applications**

• Electronic assemblies that require robust thermal management. This product is typically used in on-board chargers and inverters in battery electric vehicles

### **Available Configurations\***

- Cartridges: On request
- Pail Kits: 20 liter pail
- Drum Kits: 200 liter drum

### CLICK HERE TO LEARN MORE

### Europe

Germany Henkel AG & Co. KGaA (Headquarters) Henkelstraße 67, 40589 Düsseldorf

#### Asia-Pacific China

Henkel (China) Co., Ltd. No. 928 Zhangheng Road, Pudong New District 201203 Shanghai

#### Americas U.S.A

U.S.A. Henkel Corporation Madison Heights, 32100 Stephenson Highway Madison Heights, MI 48071



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### **Technical Data**

Properties	Typical Value	Test Methods
Chemistry	2K addition cure	-
Thermal	silicone 1.4 W/m.K	ASTM D 5470-17
Conductivity Density	2.5 g/cm <sup>3</sup>	ASTM D792
Hardness, Shore 00	70%	ASTM D 2240-15
Dielectric Strength	> 14 kV/mm	ASTM D 149
Viscosity @ 25°C, 1 s	5,500 mPa·s	ASTM D 7867-13
Pot Life @ 25°C	> 20 min	ASTM D 7867-13

### **Product Availability\***

Global

\*Availability may change due to high demand. Please contact us for the latest information.



# THERMAL POTTING

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### Sustainability:

- Non-corrosive
- Cures at low temperatures or room temperature
- Made in Europe: REACH- and RoHS-compliant



